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HUA HONG SEMICONDUCTOR LIMITED

華虹半導體有限公司

(Incorporated in Hong Kong with limited liability)

(Stock Code: 1347)

INSIDE INFORMATION COMPLETION OF RMB SHARE ISSUE AND AMENDMENTS TO ARTICLES OF ASSOCIATION

This announcement is made by Hua Hong Semiconductor Limited (the “**Company**”) pursuant to Rule 13.09 of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited (the “**Hong Kong Listing Rules**”) and the Inside Information Provisions under Part XIVA of the Securities and Futures Ordinance (Chapter 571 of the Laws of Hong Kong).

Reference is made to the Company’s announcements dated 21 March 2022, 12 May 2022, 27 June 2022, 4 November 2022, 30 January 2023, 13 April 2023, 10 May 2023, 17 May 2023, 28 May 2023, 7 June 2023, 28 June 2023, 5 July 2023, 14 July 2023, 18 July 2023, 21 July 2023, 24 July 2023, 26 July 2023, 27 July 2023 and 31 July 2023 and the Company’s circulars dated 7 June 2022, 5 June 2023 and 29 June 2023 in relation to, among others, the RMB Share Issue. Unless otherwise defined, the capitalized terms used in this announcement shall have the same meanings as those defined in the above announcements and circulars.

The Board is pleased to announce that the RMB Shares of the Company will be listed and become available for trading on the STAR Market of the Shanghai Stock Exchange on 7 August 2023. Certain key information in respect of the RMB Share Issue is as follows:

Place of listing of the RMB Shares:	The STAR Market of the Shanghai Stock Exchange
Date of listing of the RMB Shares:	7 August 2023
Stock abbreviation of the RMB Shares:	Hua Hong Company (華虹公司)
Stock code of the RMB Shares:	688347
Total number of issued shares of the Company after the RMB Share Issue as disclosed in the prospectus for the RMB Share Issue (based on number of issued Hong Kong Shares as at 30 June 2023):	1,715,897,031 Shares (comprising 407,750,000 RMB Shares and 1,308,147,031 Hong Kong Shares)

Total number of issued shares of the Company immediately after the RMB Share Issue (based on number of issued Hong Kong Shares as at 3 August 2023): 1,715,984,000 Shares (comprising 407,750,000 RMB Shares and 1,308,234,000 Hong Kong Shares)

AMENDMENTS TO ARTICLES OF ASSOCIATION

To satisfy the relevant regulatory requirements in relation to the Company's corporate governance structure after the RMB Share Issue and listing, the Shareholders of the Company approved the proposal regarding amendments to the Articles as a special resolution at the extraordinary general meeting held on 27 June 2022, details of which are set out in the Appendix V to the Previous Circular. The amended Articles shall take effect from the date of the listing of the RMB Shares on the STAR Market of the Shanghai Stock Exchange. Full text of the amended Articles will be published on the websites of the Shanghai Stock Exchange (www.sse.com.cn), the Hong Kong Stock Exchange (www.hkexnews.hk) and the Company (www.huahonggrace.com).

Shareholders and potential investors of the Company should exercise caution when dealing in the securities of the Company. This announcement is for information only and is not intended to and does not constitute, or form part of, an invitation or offer to acquire, purchase or subscribe for any securities of the Company.

By order of the Board
Hua Hong Semiconductor Limited
Mr. Suxin Zhang
Chairman and Executive Director

Shanghai, 4 August 2023

As at the date of this announcement, the directors of the Company are:

Executive Directors

Suxin Zhang (*Chairman*)
Junjun Tang (*President*)

Non-Executive Directors

Guodong Sun
Jing Wang
Jun Ye

Independent Non-Executive Directors

Stephen Tso Tung Chang
Kwai Huen Wong, JP
Long Fei Ye